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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
PO-YU LIN	09/10/2018
CHI-YU CHOU	09/10/2018
HSIEN-MING LEE	09/10/2018
HUAI-TEI YANG	09/20/2018
CHUN-CHIEH WANG	09/10/2018
YUEH-CHING PAI	09/10/2018
CHI-JEN YANG	09/10/2018
TSUNG-TA TANG	09/17/2018
YI-TING WANG	09/17/2018

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.	
Street Address:	NO. 8, LI-HSIN RD. 6	
Internal Address:	HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300-77	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16117234	

CORRESPONDENCE DATA

Fax Number: (202)371-2540

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-371-2600

Email: rsokohl@sternekessler.com, mbennett@sternekessler.com

STERNE, KESSLER, GOLDSTEIN & FOX P.L.L.C. Correspondent Name:

Address Line 1: 1100 NEW YORK AVENUE, NW Address Line 4: WASHINGTON, D.C. 20005

ATTORNEY DOCKET NUMBER: 4630.1590000

PATENT REEL: 047683 FRAME: 0928 505221554

NAME OF SUBMITTER: ROBERT SOKOHL, REG. NO. 36,013	
SIGNATURE: /Robert Sokohl Reg. No. 36,013/	
DATE SIGNED: 12/05/2018	
Total Attachments: 3	

Total Attachments: 3

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> **PATENT** REEL: 047683 FRAME: 0929

Atty. Docket No. 4630.1590000 / P20173275US00

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) or equivalent and other good and valuable consideration paid to each of the undersigned inventors: Po-Yu LIN, Chi-Yu CHOU, Hsien-Ming LEE, Huai-Tei YANG, Chun-Chieh WANG, Yueh-Ching PAI, Chi-Jen YANG, Tsung-Ta TANG, and Yi-Ting WANG, hereby sell and assign to Taiwan Semiconductor Manufacturing Co., Ltd., a corporation formed under the laws of Taiwan, Republic of China, whose mailing address is No. 8, Li-Hsin Rd. 6, Hsinchu Science Park, Hsinchu, TW 300-77 (hereafter referred to as the Assignee), his/her entire right, title and interest, including the right to sue for past infringement and to collect for all past, present and future damages, for the United States of America (as defined in 35 U.S.C. § 100) and throughout the world,

- (a) in the invention(s) known as **FORMATION AND IN-SITU ETCHING PROCESSES FOR METAL LAYERS** for which application(s) for patent in the United States of America has a filing date or a 371(c) date of <u>August 30, 2018</u> (also known as United States Application No. <u>16/117,234</u>), in any and all applications thereon, in any and all Letters Patent(s) therefor, and
- (b) in any and all applications that claim the benefit of the patent application listed above in part (a), including non-provisional applications, continuing (continuation, divisional, or continuation-in-part) applications, reissues, extensions, renewals and reexaminations of the patent application or Letters Patent therefor listed above in part (a), to the full extent of the term or terms for which Letters Patents issue, and
- (c) in any and all inventions described in the patent application listed above in part (a), and in any and all forms of intellectual and industrial property protection derivable from such patent application, and that are derivable from any and all continuing applications, reissues, extensions, renewals and reexaminations of such patent application, including, without limitation, patents, applications, utility models, inventor's certificates, and designs together with the right to file applications therefor; and including the right to claim the same priority rights from any previously filed applications under the International Agreement for the Protection of Industrial Property, or any other international agreement, or the domestic laws of the country in which any such application is filed, as may be applicable;

all such rights, title and interest to be held and enjoyed by the above-named Assignee, its successors, legal representatives and assigns to the same extent as all such rights, title and interest would have been held and enjoyed by the undersigned inventors had this assignment and sale not been made.

The undersigned inventors agree to execute all papers necessary in connection with the application(s) and any non-provisional, continuing (continuation, divisional, or continuation-in-part), reissue, reexamination or corresponding application(s) thereof and also to execute separate

assignments in connection with such application(s) as the Assignee may deem necessary or expedient.

The undersigned inventors agree to execute all papers necessary in connection with any judicial or administrative proceeding, including but not limited to an interference, derivation, post-grant proceeding, or patent enforcement action (judicial or otherwise) related to the application(s) or any non-provisional, continuing (continuation, divisional, or continuation-in-part), reissue or reexamination application(s) thereof or Letters Patent(s) therefor and to cooperate with the Assignee in every way possible in obtaining evidence and assisting with such judicial or administrative proceeding.

The undersigned inventors hereby represent that he/she has full right to convey the entire interest herein assigned, and that he/she has not executed, and will not execute, any agreement in conflict therewith.

The undersigned inventors hereby grant the patent practitioners associated with CUSTOMER NUMBER 134593 the power to insert in this assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

The undersigned inventors hereby represent that he/she understands that the patent practitioners associated with **CUSTOMER NUMBER 134593** are the legal representatives of, and attorneys for, the assignee, and are <u>NOT</u> the legal representatives of, and attorneys for, the inventors.

IN WITNESS WHEREOF, executed by the undersigned inventors on the date opposite his/her name.

Date:	2018/9/10	Signature of Inventor:	Po-Yu LIN
			Po-Yu LIN
Date:	2018/9/10	Signature of Inventor: _	chi-yu chou
			Chi-Yu CHOU
Date:	2018/9/10	Signature of Inventor:	Usian Min Jee
			Hsien-Ming LEE
Date:	2012/9/20	Signature of Inventor: _	How Te Gy
	,		Huai-Tei YANG
Date:	2018/9/10	Signature of Inventor:	Chun-Chieh Warg
			Chun-Chieh WANG

Appl. No. 16/117,234 Atty. Docket No. 4630.1590000

Signature of Inventor:

Yueh-Ching PAI Date: 78/8, 9, (2

Date: >018.9.10 Signature of Inventor: Mi-Jen (and Chi-Jen YANG

Date: 2018, 9,17

Date: 2018 9 17 Signature of Inventor: Yi - Ting Wang
Yi-Ting WANG

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RECORDED: 12/05/2018

Page 3 of 3

PATENT REEL: 047683 FRAME: 0932